

< C band internally matched power GaAs FET >

# MGFC45V3436A

3.4 – 3.6 GHz BAND / 32W

## DESCRIPTION

The MGFC45V3436A is an internally impedance-matched GaAs power FET especially designed for use in 3.4 – 3.6 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

## FEATURES

Class A operation

Internally matched to 50(ohm) system

- High output power  
P1dB=32W (TYP.) @f=3.4 – 3.6GHz
- High power gain  
GLP=12.0dB (TYP.) @f=3.4 – 3.6GHz
- High power added efficiency  
P.A.E.=36% (TYP.) @f=3.4 – 3.6GHz
- Low distortion [item -51]  
IM3=-45dBc (TYP.) @Po=34.5dBm S.C.L

## APPLICATION

- item 01 : 3.4 – 3.6 GHz band power amplifier
- item 51 : 3.4 – 3.6 GHz band digital radio communication

## QUALITY

- IG

## RECOMMENDED BIAS CONDITIONS

- VDS=10V • ID=8A • RG=25ohm

## Absolute maximum ratings (Ta=25°C)

| Symbol | Parameter                        | Ratings     | Unit |
|--------|----------------------------------|-------------|------|
| VGDO   | Gate to drain breakdown voltage  | -15         | V    |
| VGSO   | Gate to source breakdown voltage | -15         | V    |
| ID     | Drain current                    | 25          | A    |
| IGR    | Reverse gate current             | -80         | mA   |
| IGF    | Forward gate current             | 168         | mA   |
| PT *1  | Total power dissipation          | 150         | W    |
| Tch    | Channel temperature              | 175         | °C   |
| Tstg   | Storage temperature              | -65 to +175 | °C   |

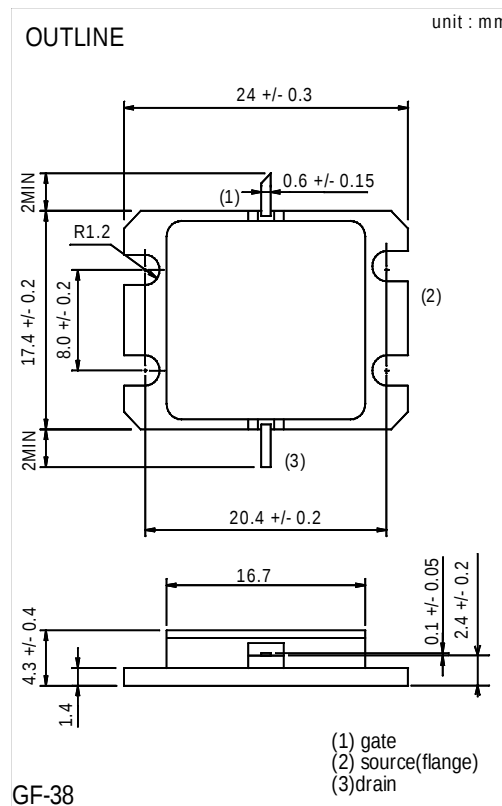
\*1 : Tc=25°C

## Electrical characteristics (Ta=25°C)

| Symbol       | Parameter                            | Test conditions                          | Limits |      |      | Unit |
|--------------|--------------------------------------|------------------------------------------|--------|------|------|------|
|              |                                      |                                          | Min.   | Typ. | Max. |      |
| IDSS         | Saturated drain current              | VDS=3V, VGS=0V                           | -      | 24   | -    | A    |
| gm           | Transconductance                     | VDS=3V, ID=8A                            | -      | 8    | -    | S    |
| VGS(off)     | Gate to source cut-off voltage       | VDS=3V, ID=160mA                         | -2     | -    | -5   | V    |
| P1dB         | Output power at 1dB gain compression | VDS=10V, ID(RF off)=8A<br>f=3.4 – 3.6GHz | 44     | 45   | -    | dBm  |
| GLP          | Linear Power Gain                    |                                          | 11     | 12   | -    | dB   |
| ID           | Drain current                        |                                          | -      | 8    | -    | A    |
| P.A.E.       | Power added efficiency               |                                          | -      | 36   | -    | %    |
| IM3 *2       | 3rd order IM distortion              |                                          | -42    | -45  | -    | dBc  |
| Rth(ch-c) *3 | Thermal resistance                   | delta Vf method                          | -      | 0.8  | 1    | °C/W |

\*2 : item -51 , 2 tone test, Po=34.5dBm Single Carrier Level , f=3.4, 3.5, 3.6GHz, delta f=10MHz

\*3 : Channel-case

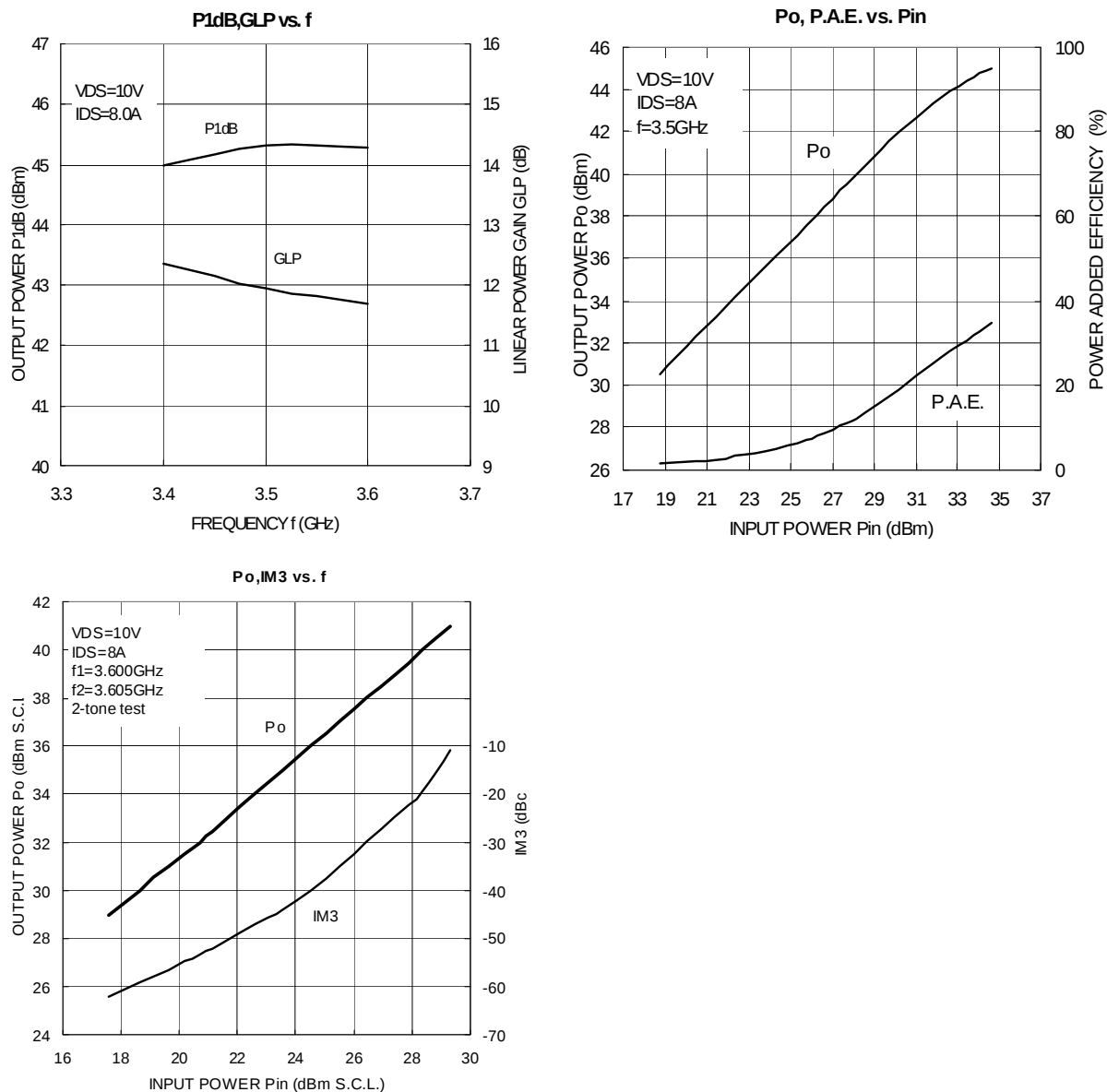


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**MGFC45V3436A TYPICAL CHARACTERISTICS**( Ta=25deg.C )**MGFC45V3436A S-parameters**( Ta=25deg.C , VDS=10(V), IDS=8.0(A) )

| f<br>(GHz) | S Parameters(Typ.) |             |       |             |       |             |       |             |
|------------|--------------------|-------------|-------|-------------|-------|-------------|-------|-------------|
|            | S11                |             | S21   |             | S12   |             | S22   |             |
|            | Magn.              | Angle(deg.) | Magn. | Angle(deg.) | Magn. | Angle(deg.) | Magn. | Angle(deg.) |
| 3.30       | 0.54               | -95         | 3.01  | 104         | 0.03  | 43          | 0.60  | 13          |
| 3.35       | 0.51               | -121        | 3.27  | 87          | 0.03  | 29          | 0.56  | 3           |
| 3.40       | 0.49               | -146        | 3.45  | 73          | 0.04  | 13          | 0.50  | -6          |
| 3.45       | 0.50               | -171        | 3.58  | 59          | 0.04  | -12         | 0.44  | -17         |
| 3.50       | 0.51               | 165         | 3.71  | 42          | 0.05  | -21         | 0.39  | -29         |
| 3.55       | 0.53               | 144         | 3.80  | 27          | 0.06  | -37         | 0.34  | -42         |
| 3.60       | 0.55               | 125         | 3.82  | 14          | 0.06  | -52         | 0.29  | -56         |
| 3.65       | 0.56               | 110         | 3.81  | -1          | 0.06  | -69         | 0.24  | -74         |
| 3.70       | 0.56               | 93          | 3.84  | -15         | 0.07  | -80         | 0.22  | -94         |

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